



Specification for Approval

Customer: _____

Model Name: _____

Supplier Approval			Customer approval
R&D Designed	R&D Approved	QC Approved	
<i>Peter</i>	<i>Peng Jun</i>		



Revision Record

REV NO.	REV DATE	CONTENTS	Note
A	2024-08-21	NEW ISSUE	



Table of Contents

No.	Item	Page
1.	General Description	4
2.	Module Parameter	4
3.	Absolute Maximum Ratings	4
4.	DC Characteristics	5
5.	Backlight Characteristic	5
5.1.	Backlight Characteristics	5
5.2.	Backlighting circuit	5
6.	Optical Characteristics	6
6.1.	Optical Characteristics	6
6.2.	Definition of Response Time	6
6.3.	Definition of Contrast Ratio	7
6.4.	Definition of Viewing Angles	7
6.5.	Definition of Color Appearance	7
6.6.	Definition of Surface Luminance, Uniformity and Transmittance	8
7.	Block Diagram and Power Supply	9
8.	Interface Pins Definition	10
9.	AC Characteristics	12
10.	Quality Assurance	14
10.1.	Purpose	14
10.2.	Standard for Quality Test	14
10.3.	Nonconforming Analysis & Disposition	14
10.4.	Agreement Items	14
10.5.	Standard of the Product Visual Inspection	14
10.6.	Inspection Specification	15
10.7.	Classification of Defects	19
10.8.	Identification/marketing criteria	19
10.9.	Packaging	19
11.	Reliability Specification	20
12.	Precautions and Warranty	21
12.1.	Safety	21
12.2.	Handling	21
12.3.	Storage	21
12.4.	Metal Pin (Apply to Products with Metal Pins)	21
12.5.	Operation	22
12.6.	Static Electricity	22
12.7.	Limited Warranty	22
13.	Packaging	23
14.	Outline Drawing	24

1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver Ics and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	5.6"	
LCD type	IPS TFT	
Display Mode	Transmissive /Normally Black	
Resolution	640 RGB x 480	Pixels
View Direction	Full View	Best Image
Gray Scale Inversion Direction	-	
Module Outline	126.5(W) × 100(H) × 5.7(D) mm	mm
Active Area	115.2(H) x86.4(V)	mm
Pixel Size	60 x180	um
Pixel Arrangement	R.G.B. Vertical Stripe	
Display Colors	16.7M	
Interface	RGB interface	
With or without touch panel	without	
Driver IC		-
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	-	g

3. Absolute Maximum Ratings

 $V_{SS}=0V, T_a=25^{\circ}C$

Item	Symbol	Min.	Max.	Unit
Supply Voltage	V _{CI}	-0.3	5.0	V
Storage temperature	T _{stg}	-30	+80	°C
Operating temperature	T _{op}	-20	+70	°C

Note 1: If T_a below $50^{\circ}C$, the maximal humidity is 90%RH, if T_a over $50^{\circ}C$, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around $-10^{\circ}C$, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	
Supply Voltage	V _{CI}	2.5	3.0	3.3	V	
Logic Low input voltage	V _{IL}	GND	-	0.3*V _{CI}	V	
Logic High input voltage	V _{IH}	0.7*V _{CI}	-	V _{CI}	V	
Logic Low output voltage	V _{OL}	GND	-	0.2*V _{CI}	V	
Logic High output voltage	V _{OH}	0.8*V _{CI}	-	V _{CI}	V	
Current Consumption All Black	Logic	I _{CC+ I_{IN}}	-	9	-	mA
	Analog					

5. Backlight Characteristic

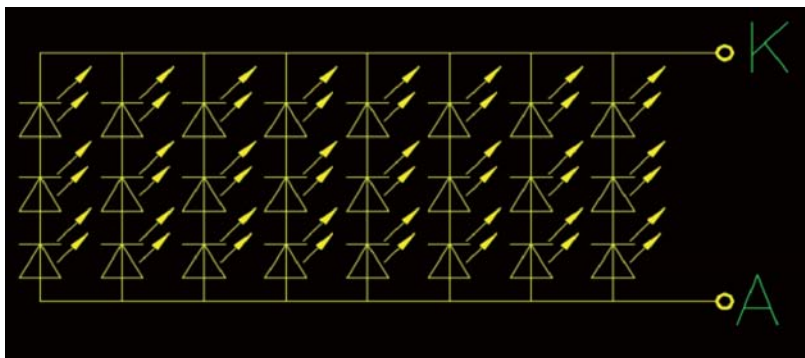
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	T _a =25 °C, I _F =20mA/LED	8.4	9.0	9.6	V
Forward Current	I _F	T _a =25 °C, V _F =3.0V/LED	-	160	-	mA
Power dissipation	P _D		-	1260	-	mW
Uniformity	Avg		80	-	-	%
LED working life(25°C)	-		-	30,000	-	Hrs
Drive method	Constant current					
LED Configuration	24 White LEDs (3 LEDs in one string and 8 groups in parallel)					

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at T_a=25±2 °C,60%RH±5%, I_F=20mA/LED.

5.2. Backlighting circuit



6. Optical Characteristics

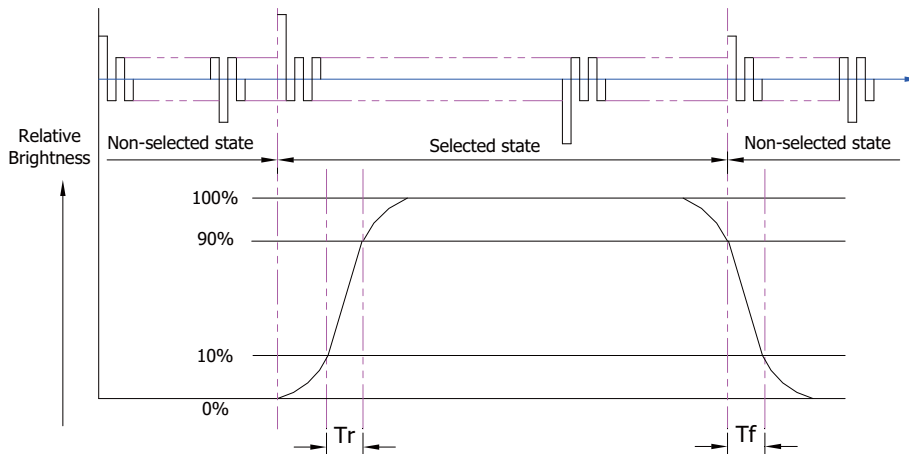
6.1. Optical Characteristics

 $T_a=25^{\circ}\text{C}$, $V_{CI}=2.8\text{V}$

	Item	Symbol	Condition	Specification			Unit	
				Min.	Typ.	Max.		
Backlight On (Transmissive Mode)	Luminance on TFT ($I_f=15\text{mA/LED}$)	Lv	Normally viewing angle $\theta_x = \phi_y = 0^{\circ}$	300	350	-	cd/m ²	
	Contrast ratio(See 6.3)	CR		1000	1200	-		
	Response time (See 6.2)	T_{R+TF}		-	30	35	ms	
	Chromaticity Transmissive (See 6.5)	White		Xw	-	-	-	
				Yw	-	-	-	
	Viewing Angle (See 6.4)	Horizontal	θ_{x+}	Center CR \geq 10	75	80	-	Deg.
			θ_{x-}		75	80	-	
		Vertical	ϕ_{y+}		75	80	-	
			ϕ_{y-}		75	80	-	
	NTSC Ratio(Gamut)			55	60	-	%	

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

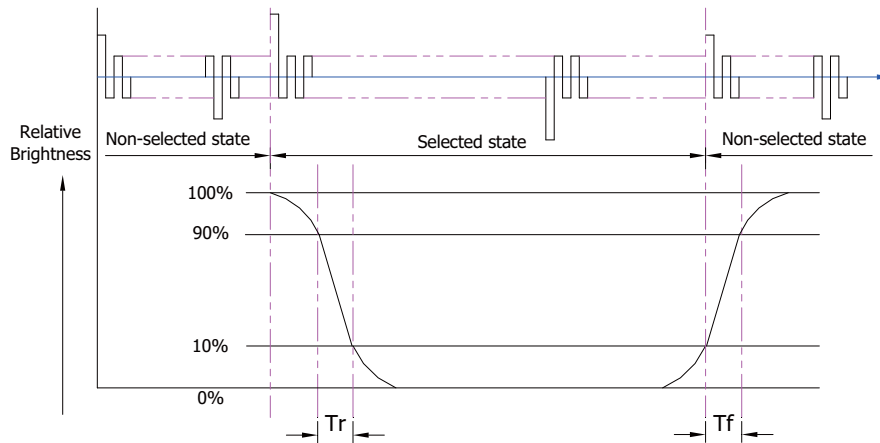


T_r is the time it takes to change from non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

T_f is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note : Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change from non-selected state with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

6.3. Definition of Contrast Ratio

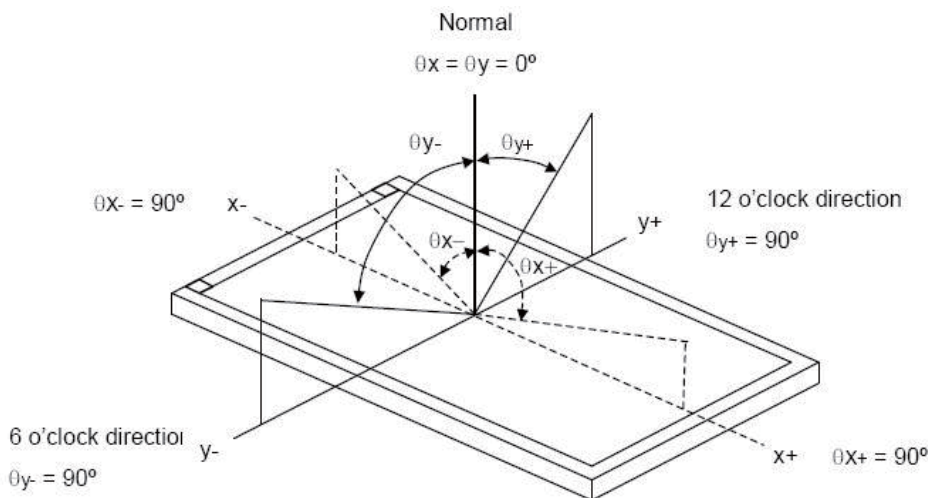
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



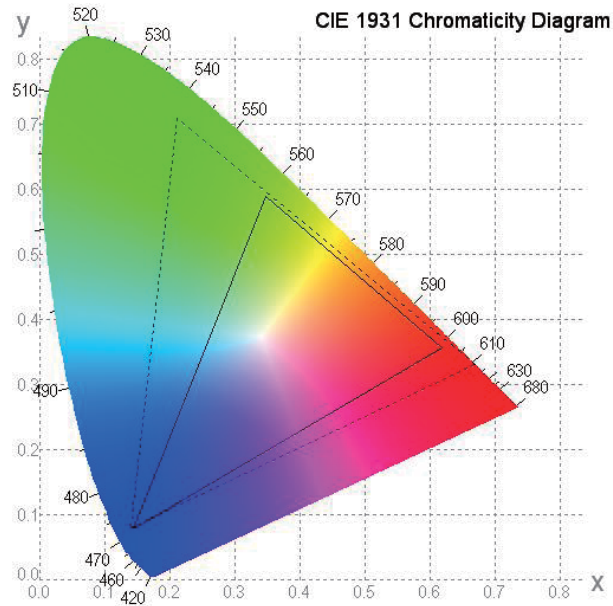
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

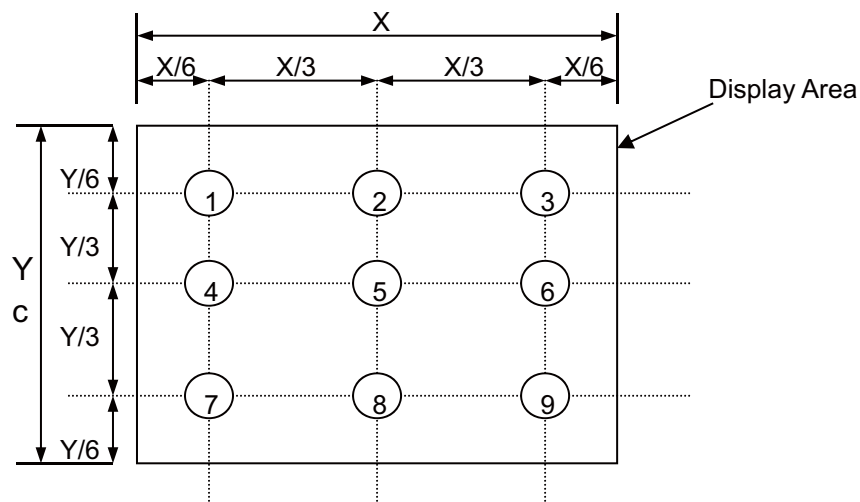


6.6. Definition of Surface Luminance, Uniformity and Transmittance

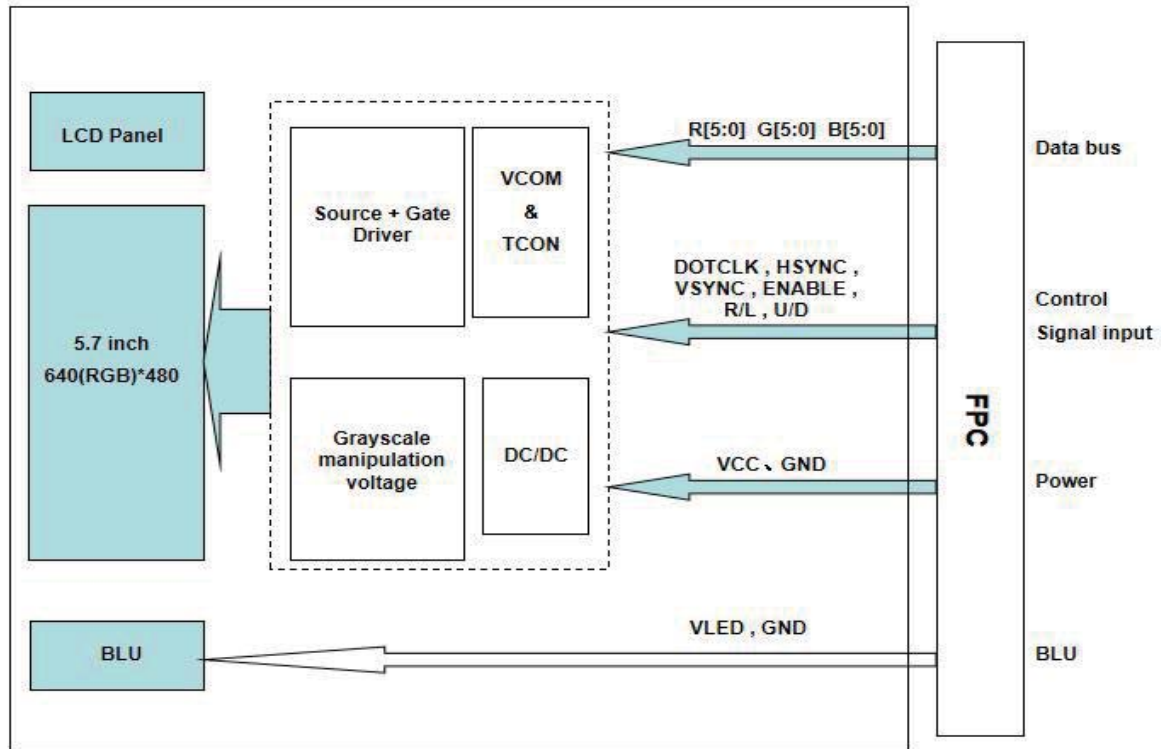
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: $L_V = \text{average} (L_{P1}:L_{P9})$
- 6.6.2. Uniformity = Minimal ($L_{P1}:L_{P9}$) / Maximal ($L_{P1}:L_{P9}$) * 100%
- 6.6.3. Transmittance = $L_V \text{ on LCD} / L_V \text{ on Backlight} * 100\%$

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply



8. Interface Pins Definition

FPC connector is used for the module electronics interface. The recommended model is FH12S-50S-0.5SH manufactured by HiRose.

Pin No.	Symbol	I/O	Function	Remark
1	V _{LED+}	P	Power for LED backlight anode	
2	V _{LED+}	P	Power for LED backlight anode	
3	V _{LED-}	P	Power for LED backlight cathode	
4	V _{LED-}	P	Power for LED backlight cathode	
5	GND	P	Power ground	
6	V _{COM}	I	V _{COM} input	
7	V _{CC}	P	Digital power supply(+3.3V)	
8	MODE	I	DE or HV mode control	Note 1
9	DE	I	Data Enable	
10	VS	I	Vsync signal input	
11	HS	I	Hsync signal input	
12	B7	I	Blue data input (MSB)	
13	B6	I	Blue data input	
14	B5	I	Blue data input	
15	B4	I	Blue data input	
16	B3	I	Blue data input	
17	B2	I	Blue data input	
18	B1	I	Blue data input	
19	B0	I	Blue data input(LSB)	
20	G7	I	Green data input(MSB)	
21	G6	I	Green data input	
22	G5	I	Green data input	
23	G4	I	Green data input	
24	G3	I	Green data input	
25	G2	I	Green data input	
26	G1	I	Green data input	
27	G0	I	Green data input(LSB)	
28	R7	I	Red data input(MSB)	
29	R6	I	Red data input	

30	R5	I	Red data input	
31	R4	I	Red data input	
32	R3	I	Red data input	
33	R2	I	Red data input	
34	R1	I	Red data input	
35	R0	I	Red data input(LSB)	
36	GND	P	Power ground	
37	DCLK	I	Sample clock	
38	GND	P	Power ground	
39	L/R	I	Select left to right scanning direction	Note 2,3
40	U/D	I	Select up or down scanning direction	Note 2,3
41	VGH	I	Positive power for scan driver	
42	VGL	I	Negative power for scan driver	
43	AV _{DD}	P	Power supply for analog circuit	
44	RESET	I	Reset	
45	POL	O	Polarity select for the line inversion control signal	
46	V _{COM}	I	V _{COM} input	
47	NC	-	No Connector	
48	NC	-	No Connector	
49	NC	-	No Connector	
50	NC	-	No Connector	

Note: I: input, O: output t, P: Power , R: Reserve

Note 1: DE Mode, Mode="H",HS floating and VS floating

HV Mode, Mode="L" and DE floating

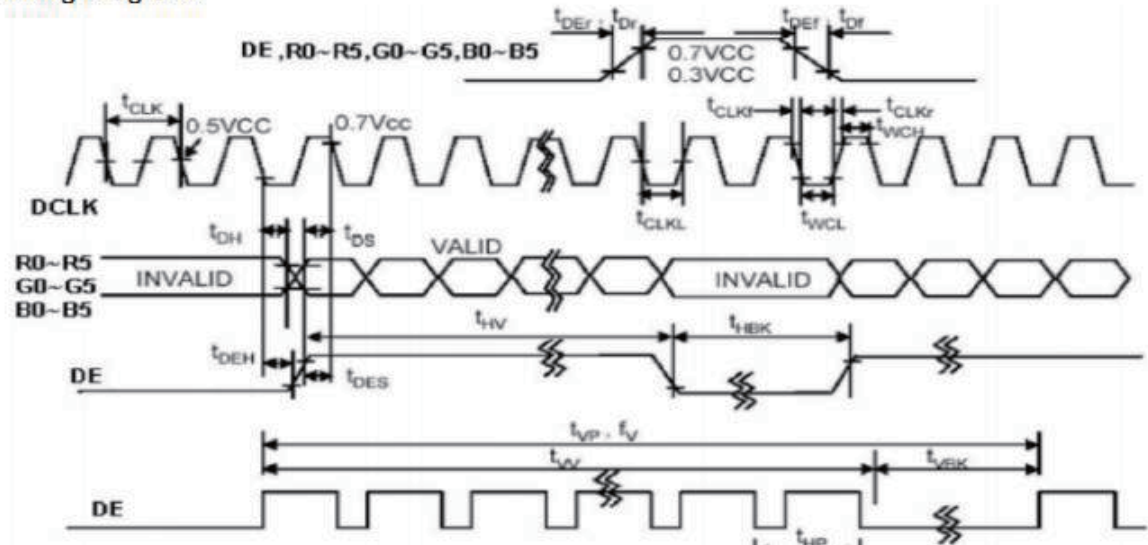
Note 2: Selection of scanning mode

Setting of scan control input		Scanning direction
U/D	L/R	
GND	V _{CC}	Up to down, left to right
V _{CC}	GND	Down to up, right to left
GND	GND	Up to down, right to left
V _{CC}	V _{CC}	Down to up, left to right

9. AC Characteristics

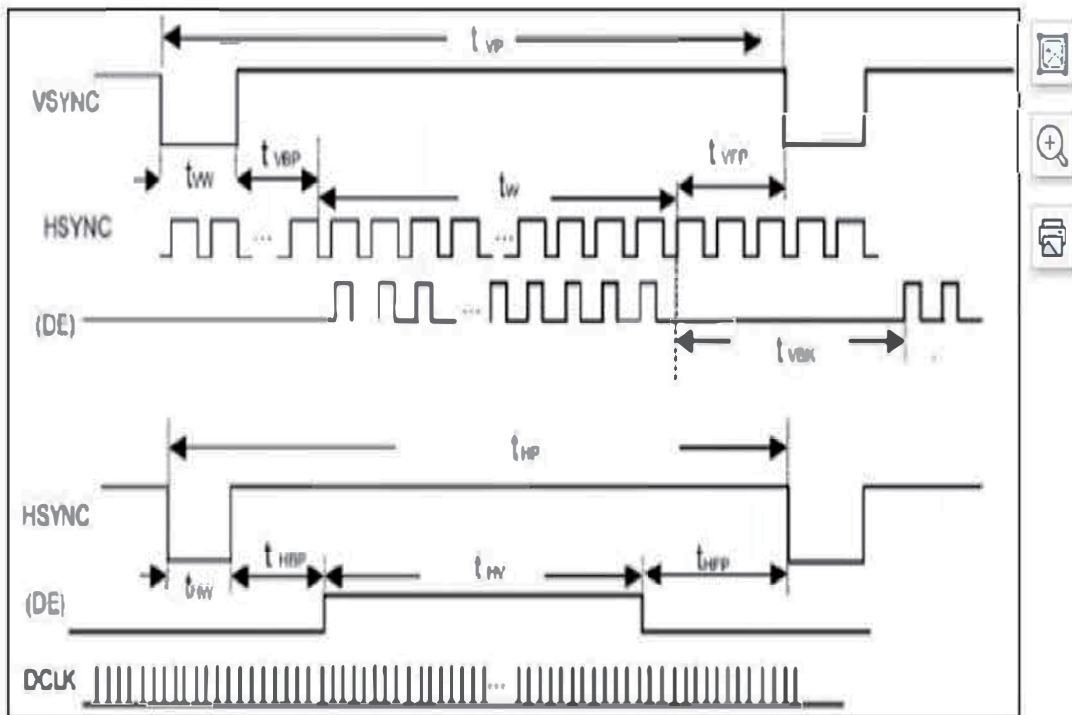
	Vertical Valid	t_w	480	480	480	tHP	
	Vertical Blank	t_{vBK}	35	45	80	tHP	
	Vertical Frequency	f_v	55	60	65	HZ	
Data R, G, B	Setup time	t_{DS}	5	-	-	ns	
	Hold time	t_{DH}	10	-	-	ns	
	Rise, Fall time	t_{Dr}, t_{Df}	-	-	3	ns	

Timing Diagram:



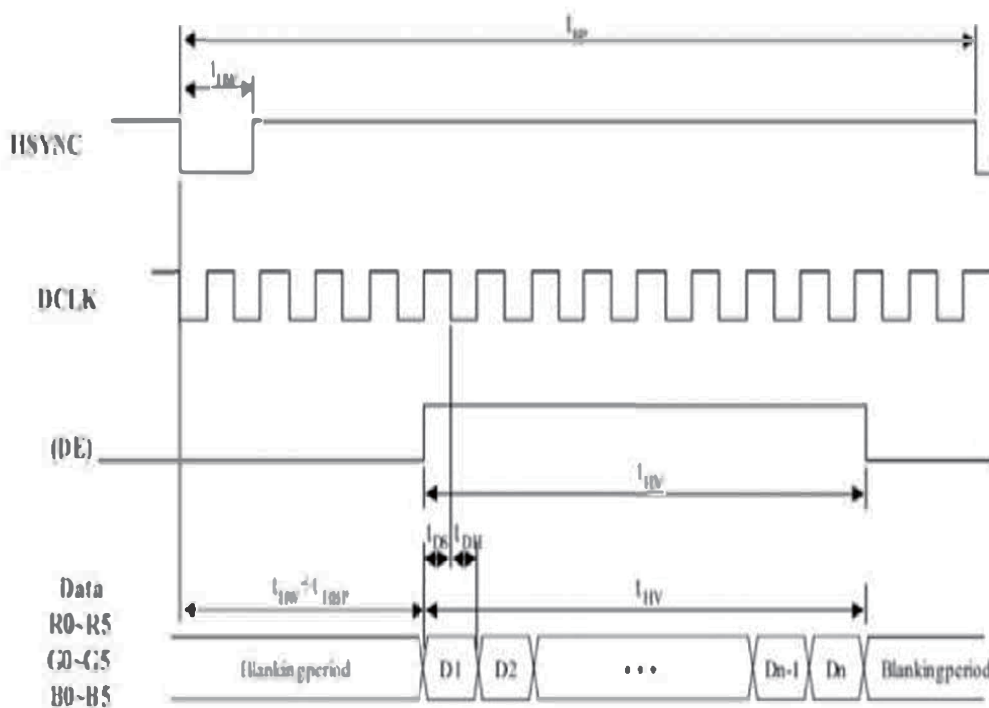
Parameter	Symbol	Min.	Typ.	Max.	Unit	Remarks
Clock Period	t_{CLK}	33	40	43	ns	
Clock Frequency	f_{CLK}	23	25	30	MHz	
Clock Low Level Width	t_{WCL}	6	-	-	ns	
Clock High Level Width	t_{WCH}	6	-	-	ns	
Clock Rise, Fall Time	t_{CLKr}, t_{CLKf}	-	-	3	ns	
HSYNC Period	tHP	750	800	900	tCLK	
HSYNC Pulse Width	tHW	5	30	-	tCLK	
HSYNC Front Porch	tHFP	1	16	116	tCLK	
HSYNC Back Porch	tHBK	1	114	139	tCLK	
HSYNC Width + Back Porch	$t_{HW} + t_{HBK}$	144	144	144	tCLK	
Horizontal Blank	tHBK	1	160	260	tCLK	
Horizontal Valid	tHV	640	640	640	tCLK	
VSYNC Period	tVP	515	525	560	tHP	
VSYNC Pulse Width	tVW	1	3	5	tHP	
VSYNC Front Porch	tVFP	1	10	45	tHP	

Input Vertical Timing



Note: if SYNC mode is used, please fix DE signal to low, DE timing waveform is for reference only.

Input Horizontal Timing



Note: if SYNC mode is used, please fix DE signal to low, DE timing waveform is for reference only.

10. Quality Assurance

10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2.Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5%

Electrical functional: AQL 0.65%.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3.Nonconforming Analysis & Disposition

10.3.1. Nonconforming analysis:

10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.

10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.

10.3.2. Disposition of nonconforming:

10.3.2.1. Non-conforming product over PPM level will be replaced.

10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4.Agreement Items

Shall negotiate with customer if the following situation occurs:

10.4.1. There is any discrepancy in standard of quality assurance.

10.4.2. Additional requirement to be added in product specification.

10.4.3. Any other special problem.

10.5.Standard of the Product Visual Inspection

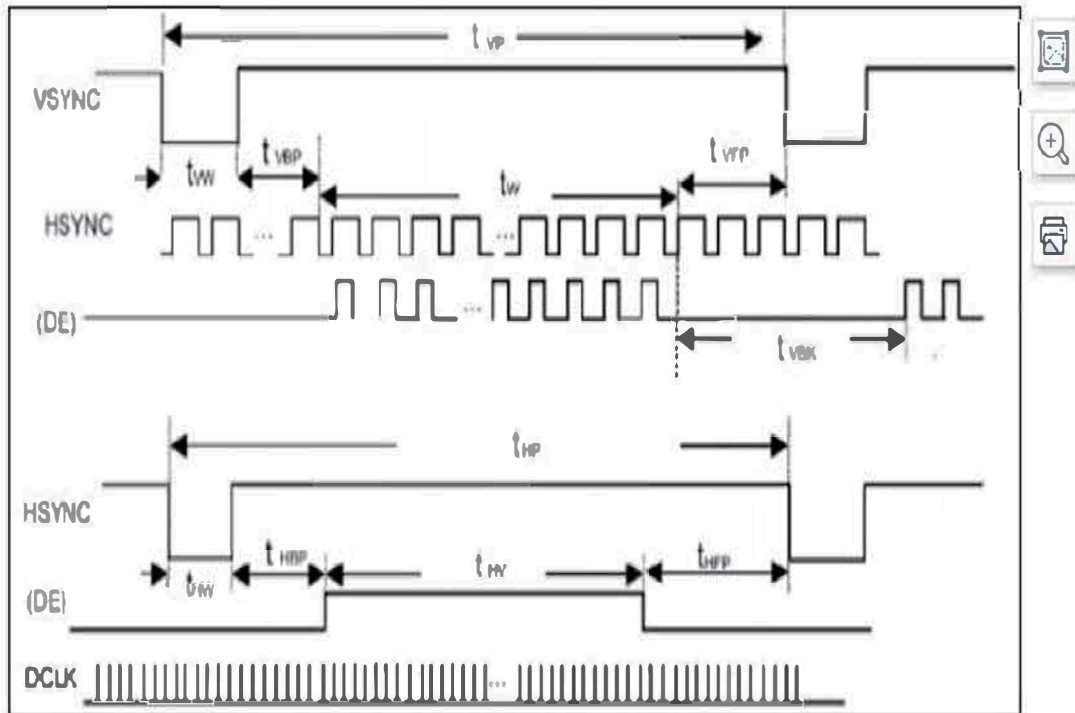
10.5.1. Appearance inspection:

10.5.1.1. The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

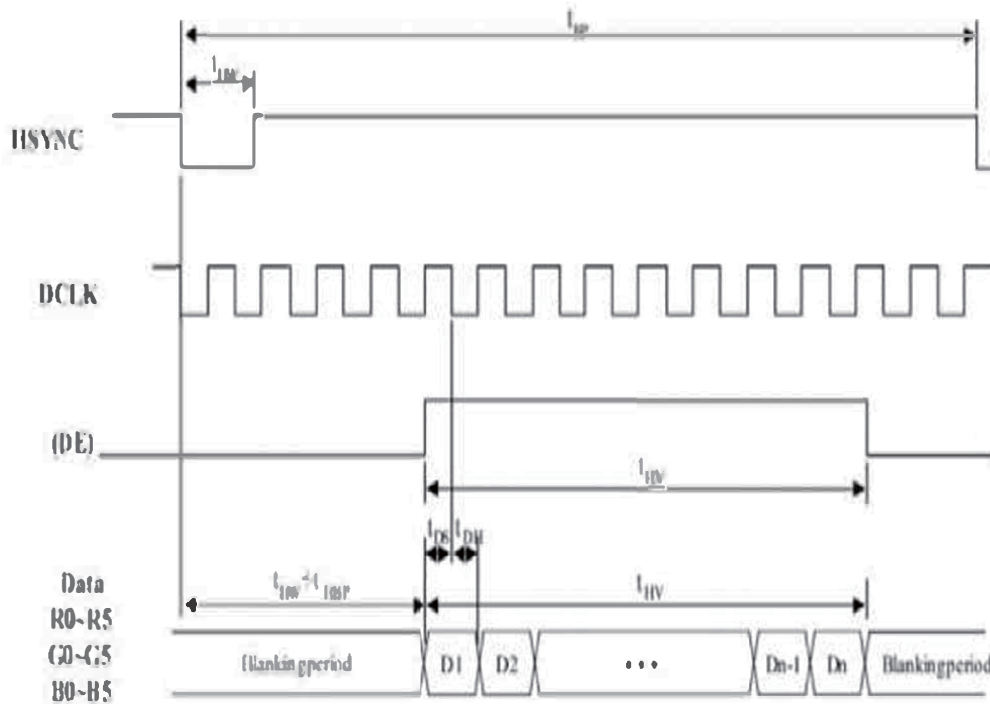
10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,

Input Vertical Timing

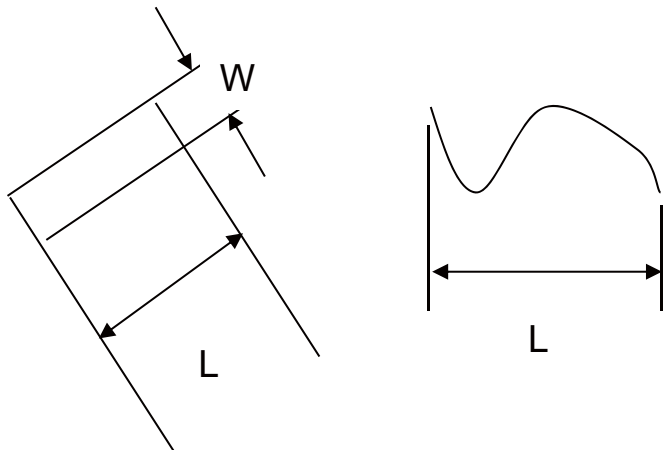
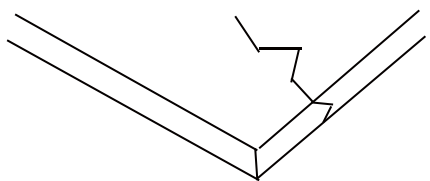


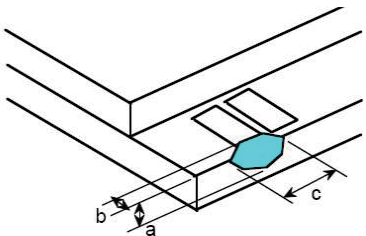
Note: If SYNC mode is used, please fix DE signal to low, DE timing waveform is for reference only.

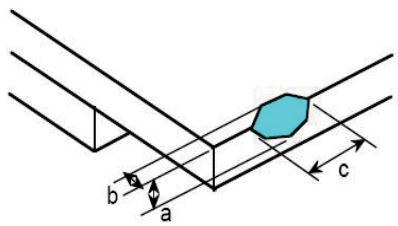
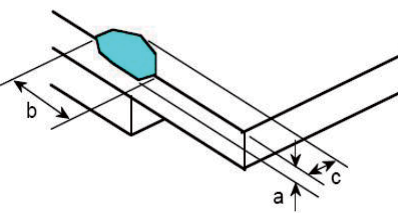
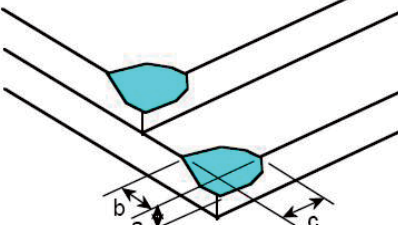
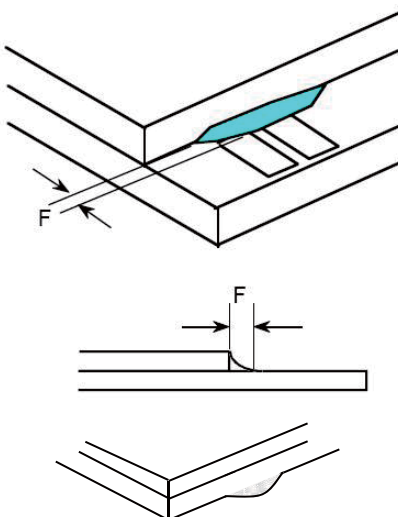
Input Horizontal Timing

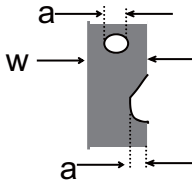


Note: If SYNC mode is used, please fix DE signal to low, DE timing waveform is for reference only.

<p>03</p>	<p>Black and White line Scratch Foreign material (Line type) (Minor defect)</p>	 <table border="1" data-bbox="614 828 1236 1131"> <thead> <tr> <th>Length</th> <th>Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>/</td> <td>$W \leq 0.03$</td> <td>Ignore</td> </tr> <tr> <td>$L \leq 2.5$</td> <td>$0.03 < W \leq 0.05$</td> <td>3</td> </tr> <tr> <td>$L \leq 2.5$</td> <td>$0.05 < W \leq 0.10$</td> <td>2</td> </tr> <tr> <td>/</td> <td>$0.1 < W$</td> <td></td> </tr> <tr> <td colspan="2">Total</td> <td>3</td> </tr> </tbody> </table> <p>Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.</p>	Length	Width	Acc. Qty	/	$W \leq 0.03$	Ignore	$L \leq 2.5$	$0.03 < W \leq 0.05$	3	$L \leq 2.5$	$0.05 < W \leq 0.10$	2	/	$0.1 < W$		Total		3
Length	Width	Acc. Qty																		
/	$W \leq 0.03$	Ignore																		
$L \leq 2.5$	$0.03 < W \leq 0.05$	3																		
$L \leq 2.5$	$0.05 < W \leq 0.10$	2																		
/	$0.1 < W$																			
Total		3																		
<p>04</p>	<p>Glass Crack (Minor defect)</p>	 <p>Crack is potential to enlarge, any type is not allowed.</p>																		

<p>05</p>	<p>Glass Chipping Pad Area: (Minor defect)</p> 	<table border="1" data-bbox="869 1713 1340 1892"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>3</td> </tr> <tr> <td colspan="2">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	3	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty									
$c > 3.0, b < 1.0$	1									
$c < 3.0, b < 1.0$	3									
$a < \text{Glass Thickness}$										

06	<p>Glass Chipping Rear of Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
07	<p>Glass Chipping Except Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
08	<p>Glass Corner Chipping: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c < 3.0, b < 3.0$</td> <td>Ignore</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c < 3.0, b < 3.0$	Ignore	$a < \text{Glass Thickness}$					
Length and Width	Acc. Qty											
$c < 3.0, b < 3.0$	Ignore											
$a < \text{Glass Thickness}$												
09	<p>Glass Burr: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$F < 1.0$</td> <td>Ignore</td> </tr> </tbody> </table> <p>Glass burr don't affect assemble and module dimension.</p>	Length	Acc. Qty	$F < 1.0$	Ignore						
Length	Acc. Qty											
$F < 1.0$	Ignore											

10	<p>FPC Defect: (Minor defect)</p> 	<p>10.1 Dent, pinhole width $a < w/3$. (w: circuitry width.) 10.2 Open circuit is unacceptable. 10.3 No oxidation, contamination and distortion.</p>										
11	Bubble on Polarizer (Minor defect)	<table border="1"> <thead> <tr> <th>Diameter</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.20$</td> <td>Ignore</td> </tr> <tr> <td>$0.20 < \varphi \leq 0.30$</td> <td>4</td> </tr> <tr> <td>$0.30 < \varphi \leq 0.50$</td> <td>1</td> </tr> <tr> <td>$0.50 < \varphi$</td> <td>None</td> </tr> </tbody> </table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
12	Dent on Polarizer (Minor defect)	<table border="1"> <thead> <tr> <th>Diameter</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.20$</td> <td>Ignore</td> </tr> <tr> <td>$0.20 < \varphi \leq 0.30$</td> <td>4</td> </tr> <tr> <td>$0.30 < \varphi \leq 0.50$</td> <td>1</td> </tr> <tr> <td>$0.50 < \varphi$</td> <td>None</td> </tr> </tbody> </table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
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$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
13	Bezel	<p>13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination.</p>										
14	Touch Panel	<p>D: Diameter W: width L: length 14.1 Spot: $D < 0.25$ is acceptable $0.25 \leq D \leq 0.4$ 2dots are acceptable and the distance between defects should more than 10 mm. $D > 0.4$ is unacceptable 14.2 Dent: $D > 0.40$ is unacceptable 14.3 Scratch: $W \leq 0.03, L \leq 10$ is acceptable, $0.03 < W \leq 0.10, L \leq 10$ is acceptable Distance between 2 defects should more than 10 mm. $W > 0.10$ is unacceptable.</p>										
15	PCB	<p>15.1 No distortion or contamination on PCB terminals. 15.2 All components on PCB must same as documented on the BOM/component layout. 15.3 Follow IPC-A-600F.</p>										
16	Soldering	Follow IPC-A-610C standard										
17	Electrical Defect (Major defect)	<p>The below defects must be rejected. 17.1 Missing vertical / horizontal segment, 17.2 Abnormal Display.</p>										

		<p>17.3 No function or no display. 17.4 Current exceeds product specifications. 17.5 LCD viewing angle defect. 17.6 No Backlight. 17.7 Dark Backlight. 17.8 Touch Panel no function.</p>
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Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7. Classification of Defects

- 10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2. Two minor defects are equal to one major in lot sampling inspection.

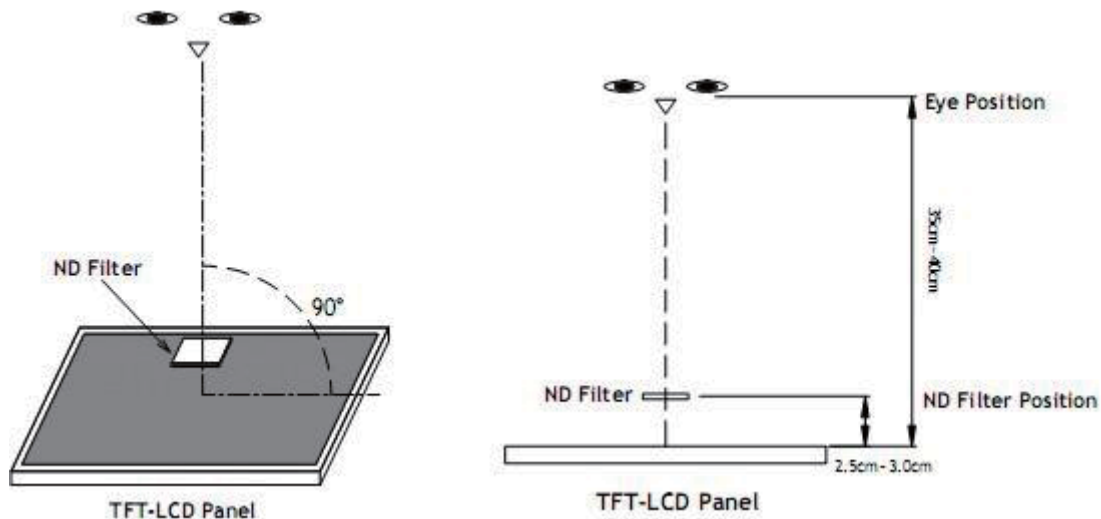
10.8. Identification/marketing criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

10.9. Packaging

- 10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2. Modules inside package box should have compliant mark.
- 10.9.3. All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350\text{mm} \pm 50\text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350\text{mm} \pm 50\text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70°C, 96Hrs	2	GB/T2423.2-2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1-2008
3	High Humidity	50°C, 90%RH, 96Hrs	2	GB/T2423.3-2006
4	High Temperature Storage	80°C, 96Hrs	2	GB/T2423.2-2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1-2008
6	Thermal Cycling Test	-20°C, 60min~70°C, 60min, 20 cycles.	2	GB/T2423.22-2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14-2009
8	Electrical Static Discharge	Air: ±8KV 150pF/330 Ω 5 times	2	GB/T17626.2-2006
		Contact: ±4KV 150pF/330 Ω 5 times		
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8-1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value.

12. Precautions and Warranty

12.1. Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2. Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3. Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

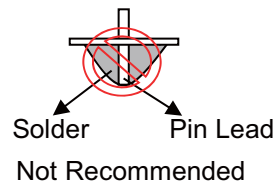
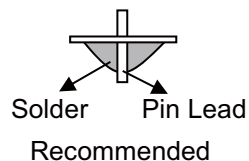
Maximum Solder Temperature: 370°C

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20°C

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



12.4.2. Pins of EL

12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290°C

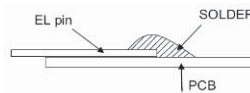
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body): 2.0mm

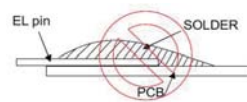
12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

12.4.2.6. Solder Wetting

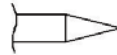


Recommended

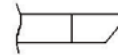


Not Recommended

12.4.2.7. The type of the solder iron:



Recommended



Not Recommended

12.4.2.8. Solder Pad



12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it may develop image sticking due to the TFT structure.

12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7. Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.



13. Packaging

TBD

14. Outline Drawing

